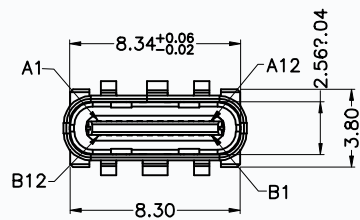


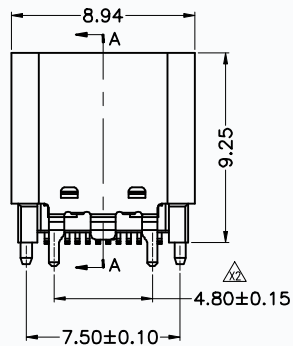
A

A



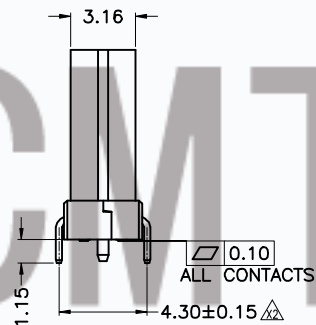
B

B



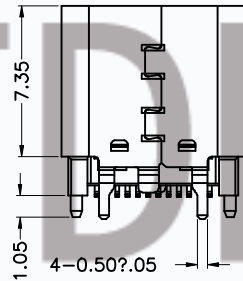
C

C



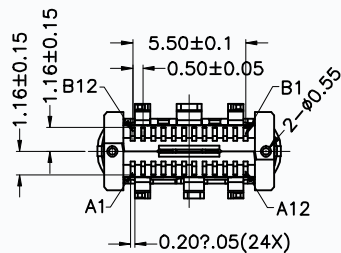
D

D



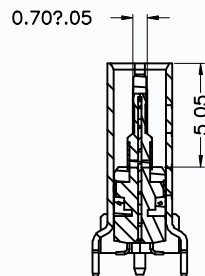
E

E



F

F



SECTION A-A

T11-24LS05-9.25H-XX-R

Mating Area plating

- 01: Au 1u"Min.
- 03: Au 3u"Min.
- 05: Au 5u"Min.
- 10: Au 10u"Min.
- 15: Au 15u"Min.
- 30: Au 30u"Min.

NOTE:

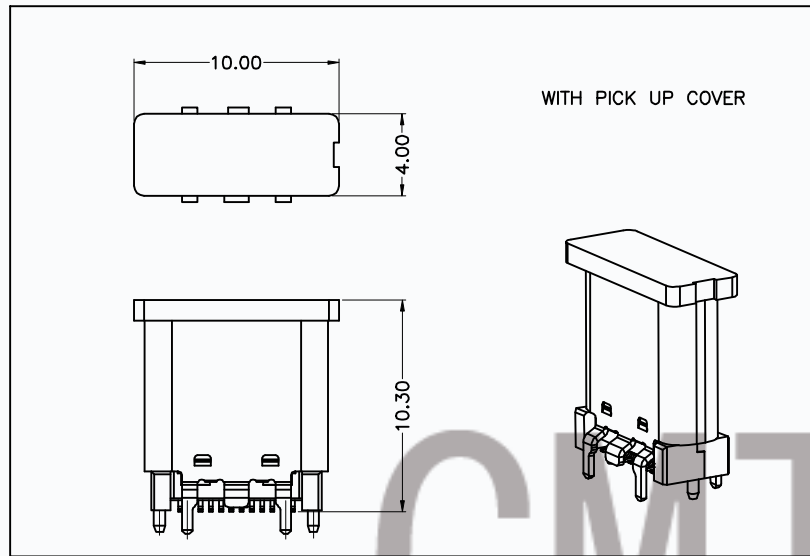
- 1.MATERIAL SPECIFICATION:
 - 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC(LCP),UL94 V-0.
 - 2.CONTACTS:COPPER ALLOY(C18150)T=0.12mm
 - 3.MID PLATE: STAINLESS STEEL(SUS301)T=0.15mm
 - 4.EMI PLATE: STAINLESS STEEL(SUS301)T=0.10mm
 - 5.SHELL: STAINLESS STEEL(SUS304)T=0.30mm
- 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
 - Ni 50u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT. (GOLD PLATING THICKNESS FOLLOW THE P/N)
 - Sn PLATED ON THE SOLDER AREA OF CONTACT.
 - 2-2.SHELL:
 - Ni 30u" MIN. UNDER PLATED OVER ALL.
 - 2-3.MID PLATE:
 - CLEAR ONLY
 - 2-4.EMI PLATE:
 - CLEAR ONLY
- 3.MECHANICAL PERFORMANCE,
 - 3-1.INSERTION FORCE: 5~20N.
 - 3-2.REMOVAL FORCE: 8~20N,6~20N AFTER TEST;
 - 3-3.DURABILITY: 10000 CYCLES.
- 4.ELECTRICAL PERFORMANCE,
 - 4-1. CURRENT RATING:5.0A
 - VOLTAGE RATING:5.0V
 - 4-2. LLCR:
 - VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
 - SHIELD: 50mΩ/MAX.
 - LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 - 4-3.INSULATION RESISTANCE: 100MΩ MIN
 - 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
5. ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -25°C~+85°C.
- 6.IR REFLOW:
 - THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.

Item	Title	Material	Dispose	Remark
1	Shell	Stainless Steel	Ni:30u" Min.	
2	GND Plate	Stainless Steel	Clear Only	
3	Mid Plate	Stainless Steel	Clear Only	
4	Top Contact	Copper Alloy	Mating Area: See P/N Solder Tails: Matt Tin	
5	Bottom Contact	Copper Alloy		
6	Insulator	High Temperature Plastic	UL 94V-0	Black

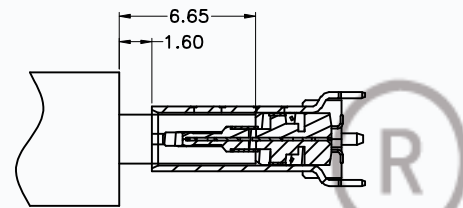
X. ± 0.35	APPD:	TITLE:	PART NO:
.X ± 0.30	JEFF	USB 3.1 TYPE C FEMALE	T11-24LS05-9.25H
.XX ± 0.25	CHKD:	VERTICAL H9.25mm SMT TYPE	
.XXX±			
X' ± 2'	DR:	CMTDZ 东莞市田都科技有限公司	
.X' ± 1.5'	ERIC	Dongguan TianDu Technology Co., Ltd.	
	UNITS: mm	SCALE: 3:1	DWG NO: CUSTOMER DRAWING
			T11-24LS05-9.25H
			SHEET:10F2
			REV: X2

X2	TD2020-XXXX	Change the tolerance and material	ERIC	2020/03/03
A	TD2019-XXXX	New Drawing	ERIC	2019/11/07
REV	ECN NO	DESCRIPTION	DESIGN	DATE

A



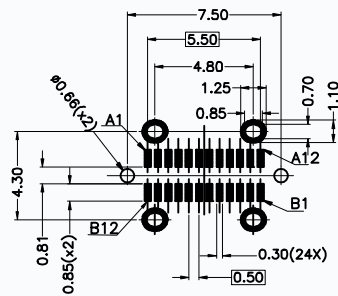
WITH PICK UP COVER



AFTER MATING

USB TYPE-C PIN ASSIGNMENTS

PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A2	SSTXp1	B11	SSRXp1
A3	SSTXn1	B10	SSRXn1
A4	Vbus	B9	Vbus
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	Vbus	B4	Vbus
A10	SSRXn2	B3	SSTXn2
A11	SSRXp2	B2	SSTXp2
A12	GND	B1	GND



RECOMMENDED PCB LAYOUT(TOP VIEW)
THICKNESS 1.5±0.10MM;DEFAULT TOLERANCE:±0.05

D

E

F

REV	ECN NO	DESCRIPTION	DESIGN	DATE
X2	TD2020-XXXX	Change the tolerance and material	ERIC	2020/03/03
A	TD2019-XXXX	New Drawing	ERIC	2019/11/07

X. ± 0.35	APPD: JEFF	TITLE: USB 3.1 TYPE C FEMALE	PART NO: T11-24LS05-9.25H
.X ± 0.30	CHKD: /	VERTICAL H9.25mm SMT TYPE	
.XX ± 0.25	DR: ERIC	CMTDOZ 东莞市田都科技有限公司 Dongguan Tiandu Technology Co., Ltd.	
.XXX±		DWG NO: T11-24LS05-9.25H	CUSTOMER DRAWING SHEET:20F2
X' ± 2°		SCALE: 3:1	REV: X2
.X' ± 1.5°			